UFZVFH6.8B

Zener Diode

(AEC-Q101 qualified) Data sheet

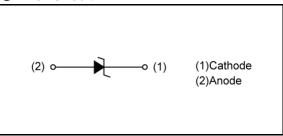
P_D 500 mW

Outline

| Package Code | SOD-323FL |] |
|--------------|-----------|---|
| JEITA Code | SC-90A | |
| ROHM Code | UMD2 | |
| | (2) | |

● FeatureHigh reliabilitySmall mold type

Inner Circuit



ApplicationVoltage regulation

Packaging Specification

| Packing | Embossed Tape | | | | |
|--------------------------|---------------|--|--|--|--|
| Reel Size(mm) | 180 | | | | |
| Taping Width(mm) | 8 | | | | |
| Basic Ordering Unit(pcs) | 3000 | | | | |
| Taping Code | TE-17 | | | | |
| Marking | DB | | | | |

StructureSilicon Epitaxial Planar

• Absolute Maximum Rating $(T_a = 25^{\circ}C)$

| Parameter | Symbol | Limits | Unit | | |
|----------------------|------------------|-----------|------|--|--|
| Power dissipation* | P_{D} | 500 | mW | | |
| Junction temperature | Tj | 150 | °C | | |
| Storage temperature | T _{stg} | -55 ~ 150 | °C | | |

^{*} Mounting on FR-5board (3.5×1.5[inches])

● Characteristic (T_a = 25°C)

| | Symbol | | | | | | |
|-----------|----------------------------------|--------|---------------------|----------------------------------|---------------------|-------------------------------------|--------------------|
| P/N | Zener Voltage:V _Z (V) | | | Dynamic Impedance: $Z_Z(\Omega)$ | | Reverse Current:I _R (µA) | |
| | MIN. | MAX. | I _z (mA) | MAX. | l _z (mA) | MAX. | V _R (V) |
| UFZV 3.6B | 3.580 | 3.836 | 20 | 60 | 20 | 10.0 | 1.0 |
| UFZV 3.9B | 3.870 | 4.151 | 20 | 50 | 20 | 5.0 | 1.0 |
| UFZV 4.3B | 4.151 | 4.423 | 20 | 40 | 20 | 5.0 | 1.0 |
| UFZV 4.7B | 4.534 | 4.795 | 20 | 25 | 20 | 5.0 | 1.0 |
| UFZV 5.1B | 4.940 | 5.200 | 20 | 20 | 20 | 5.0 | 1.5 |
| UFZV 5.6B | 5.450 | 5.730 | 20 | 13 | 20 | 5.0 | 2.5 |
| UFZV 6.2B | 5.976 | 6.307 | 20 | 10 | 20 | 5.0 | 3.0 |
| UFZV 6.8B | 6.525 | 6.865 | 20 | 8 | 20 | 2.0 | 3.5 |
| UFZV 7.5B | 7.104 | 7.509 | 20 | 8 | 20 | 0.5 | 4.0 |
| UFZV 8.2B | 7.827 | 8.265 | 20 | 8 | 20 | 0.5 | 5.0 |
| UFZV 9.1B | 8.635 | 9.106 | 20 | 8 | 20 | 0.5 | 6.0 |
| UFZV 10B | 9.497 | 10.050 | 20 | 8 | 20 | 0.2 | 7.0 |
| UFZV 11B | 10.550 | 11.160 | 10 | 10 | 10 | 0.2 | 8.0 |
| UFZV 12B | 11.510 | 12.160 | 10 | 12 | 10 | 0.2 | 9.0 |
| UFZV 13B | 12.640 | 13.340 | 10 | 14 | 10 | 0.2 | 10.0 |
| UFZV 15B | 14.000 | 14.790 | 10 | 16 | 10 | 0.2 | 11.0 |
| UFZV 16B | 15.390 | 16.240 | 10 | 18 | 10 | 0.2 | 12.0 |
| UFZV 18B | 17.000 | 17.950 | 10 | 23 | 10 | 0.2 | 13.0 |
| UFZV 20B | 18.870 | 19.890 | 10 | 28 | 10 | 0.2 | 15.0 |
| UFZV 22B | 20.770 | 21.920 | 5 | 30 | 5 | 0.2 | 17.0 |
| UFZV 24B | 22.780 | 24.020 | 5 | 35 | 5 | 0.2 | 19.0 |
| UFZV 27B | 25.190 | 26.560 | 5 | 45 | 5 | 0.2 | 21.0 |
| UFZV 30B | 27.980 | 29.500 | 5 | 55 | 5 | 0.2 | 23.0 |
| UFZV 33B | 30.660 | 32.320 | 5 | 65 | 5 | 0.2 | 25.0 |
| UFZV 36B | 33.230 | 35.010 | 5 | 75 | 5 | 0.2 | 27.0 |
| UFZV 39B | 35.880 | 37.790 | 5 | 85 | 5 | 0.2 | 30.0 |

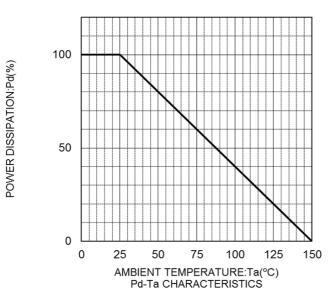
⁽¹⁾ Zener voltage (V_Z) is measured by applying current with 40ms pulse.

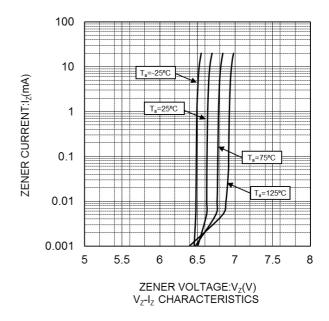
Marking

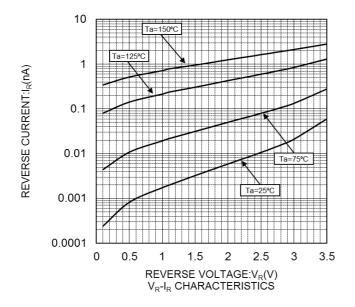
| P/N | Marking | Marking P/N | |
|-----------|---------|-------------|----|
| UFZV 3.6B | 6B | UFZV 12B | KB |
| UFZV 3.9B | 7B | UFZV 13B | LB |
| UFZV 4.3B | 8B | UFZV 15B | MB |
| UFZV 4.7B | 9B | UFZV 16B | NB |
| UFZV 5.1B | AB | UFZV 18B | PB |
| UFZV 5.6B | BB | UFZV 20B | QB |
| UFZV 6.2B | CB | UFZV 22B | RB |
| UFZV 6.8B | DB | UFZV 24B | SB |
| UFZV 7.5B | B | UFZV 27B | TΒ |
| UFZV 8.2B | FB | UFZV 30B | UB |
| UFZV 9.1B | GB | UFZV 33B | VB |
| UFZV 10B | HB | UFZV 36B | WB |
| UFZV 11B | JB | UFZV 39B | XВ |

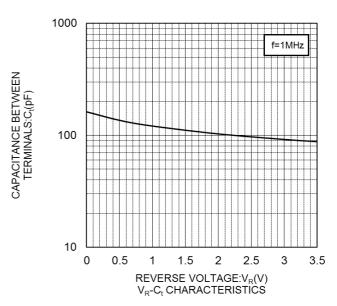
⁽²⁾ Dynamic resistance (Z_Z) is measured by applying small current (AC) and specifiedcurrent (I_Z) simultaneously.

Characteristic Curves

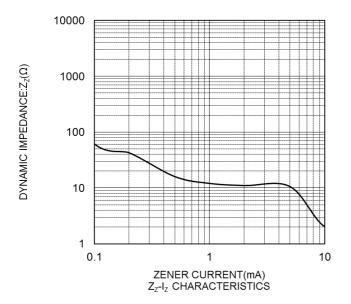


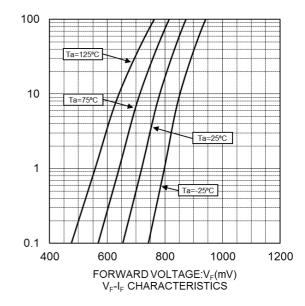


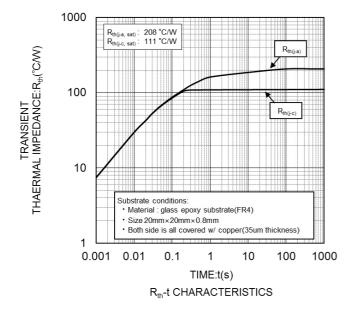




Characteristic Curves

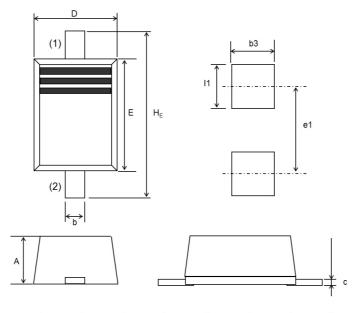






FORWARD CURRENT:IF(mA)

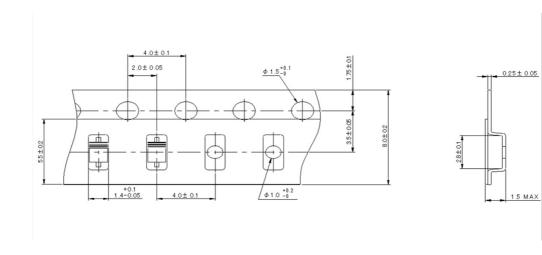
● Dimensions (SOD-323FL SC-90A UMD2)



| DIM | Milimeters | | | | | |
|-------|------------|---------|------|-------|---------|-------|
| DIIVI | Min. | Average | Max. | Min. | Average | Max. |
| А | 0.60 | 0.70 | 0.90 | 0.024 | 0.028 | 0.035 |
| b | 0.25 | 0.30 | 0.35 | 0.010 | 0.012 | 0.014 |
| С | 0.05 | 0.10 | 0.20 | 0.002 | 0.004 | 0.008 |
| D | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| Е | 1.60 | 1.70 | 1.80 | 0.063 | 0.067 | 0.071 |
| HE | 2.30 | 2.50 | 2.70 | 0.091 | 0.098 | 0.106 |
| I1 | 0.80 | - | - | 0.031 | - | - |
| b3 | 0.90 | - | - | 0.035 | - | - |
| e1 | _ | 2 10 | (=) | (=) | 0.083 | _ |

- (1) The marking bar indicates the cathode.(2) The direction indicates the anode.

● Taping (Unit:mm)



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(Note1) Medical Equipment Classification of the Specific Applications

| JÁPAN | USA | L EU | CHINA |
|---------|-------|-------|---------------|
| CLASSI | CLASS | CLASS | II b CLASSIII |
| CLASSIN | CLASS | CLASS | II CLASSIII |

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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